

2A Avg.

40 Volts

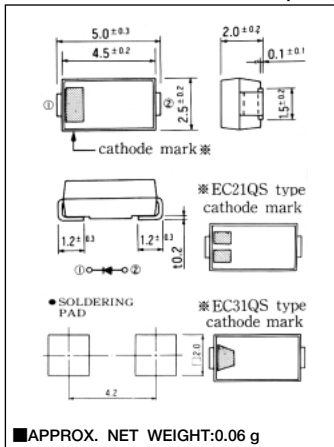
SBD

EC21QS04

■最大定格 Maximum Ratings

Item	Symbol	Conditions	Unit
くり返しピーク逆電圧 Repetitive Peak Reverse Voltage	V_{RRM}	40	V
平均整流電流 Average Rectified Forward Current	I_O	50Hz, 正弦半波通電抵抗負荷 50Hz Half Sine Wave Resistive Load	$T_a=27^{\circ}\text{C}^*$ 1.3 A
			$T_l=103^{\circ}\text{C}$ Tl:lead Temperature 2.0 A
実効順電流 R.M.S. Forward Current	$I_{F(RMS)}$	3.14	A
サージ順電流 Surge Forward Current	I_{FSM}	60 50Hz正弦半波, 1サイクル, 非くり返し 50Hz Half Sine Wave, 1cycle, Non-repetitive	A
動作接合温度範囲 Operating Junction Temperature Range	T_{jw}	-40~+150	$^{\circ}\text{C}$
保存温度範囲 Storage Temperature Range	T_{stg}	-40~+150	$^{\circ}\text{C}$

■OUTLINE DRAWING(mm)



■電氣的・熱的特性 Electrical/Thermal Characteristics

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
ピーク逆電流 Peak Reverse Current	I_{RM}	$T_j=25^{\circ}\text{C}, V_{RM}=V_{RRM}$	—	—	1	mA
ピーク順電圧 Peak Forward Voltage	V_{FM}	$T_j=25^{\circ}\text{C}, I_{FM}=2\text{A}$	—	—	0.55	V
熱抵抗 Thermal Resistance	$R_{th(j-a)}$	接合部・周囲間 Junction to Ambient Alumina Substrate Mounted*	—	—	108	$^{\circ}\text{C}/\text{W}$
	$R_{th(j-l)}$	接合部・リード間 Junction to Lead	—	—	23	$^{\circ}\text{C}/\text{W}$

*アルミナ基板実装/Alumina Substrate mounted (Soldering Lands= 2 × 2 mm, Both Sides)

■定格・特性曲線

